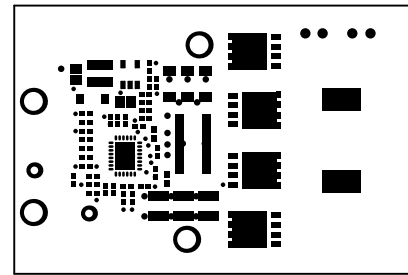
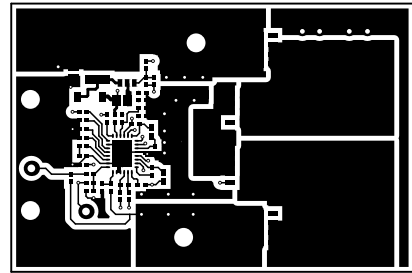


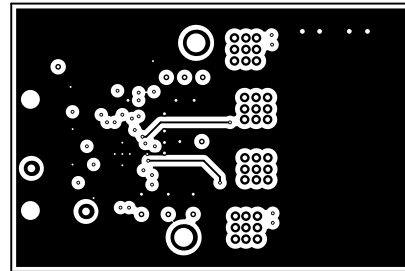
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP20410		
PLOT NAME = Top Overlay	GENERATED : 8/3/2016	12:05:49 PM	TEXAS INSTRUMENTS



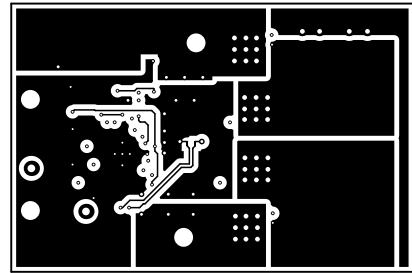
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP20410		
PLOT NAME = Top Solder Mask	GENERATED : 8/3/2016 12:05:50 PM	TEXAS INSTRUMENTS	



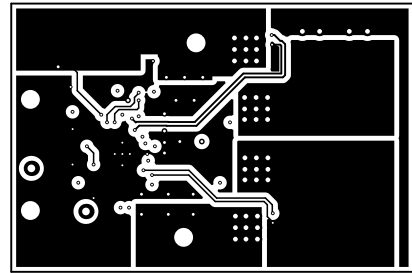
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP20410		
PLOT NAME = Top Layer	GENERATED : 8/3/2016 12:05:51 PM	TEXAS INSTRUMENTS	



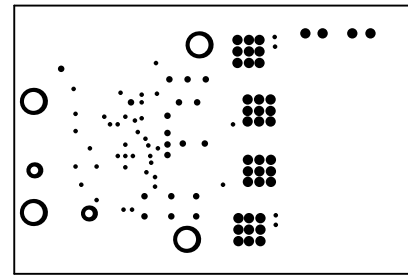
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP20410		
PLOT NAME = Signal Layer 1	GENERATED : 8/3/2016 12:05:53 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP20410		
PLOT NAME = Signal Layer 2	GENERATED : 8/3/2016 12:05:54 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP20410		
PLOT NAME = Bottom Layer	GENERATED : 8/3/2016 12:05:55 PM	TEXAS INSTRUMENTS	



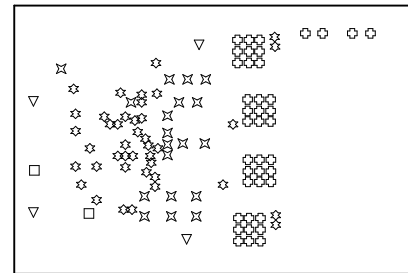
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP20410		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/3/2016 12:05:56 PM	TEXAS INSTRUMENTS	



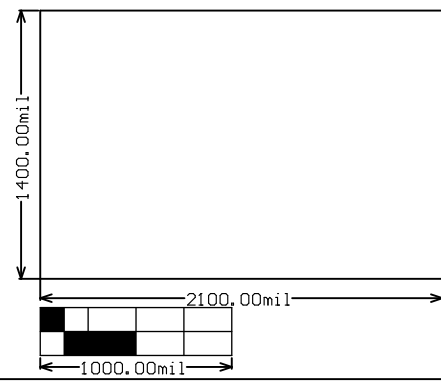
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: PMP20410		
PLOT NAME = Bottom Overlay	GENERATED : 8/3/2016 12:05:58 PM		TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
☆	41	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	
✕	19	15.00mil (0.381mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	40	25.00mil (0.635mm)	PTH	Round	Top Layer - Bottom Layer	
□	2	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
▽	4	98.43mil (2.500mm)	PTH	Round	Top Layer - Bottom Layer	
106 Total						



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP20410		
PLOT NAME = Drill Drawing	GENERATED : 8/3/2016	12:05:59 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP20410	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP20410		
PLOT NAME = Board Dimensions	GENERATED : 8/3/2016 12:06:01 PM	TEXAS INSTRUMENTS	

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